

# Product data sheet

Specifications



standalone processor, Modicon M580, 24MB, 61 Ethernet devices, 31 remote IO racks of X80 and Quantum, conformal coating

BMEP585040C

**Product availability: Non-Stock - Not normally stocked in distribution facility**

## Main

Range of Product	Modicon M580
Product or Component Type	Processor module
Impregnation material	Conformal coated

## Complementary

Number of racks	8
Local I/O processor capacity (discrete)	5120 I/O
Local I/O processor capacity (analog)	1280 I/O
Number of application specific channel (local rack)	180
Application specific I/O	Accurate time stamping Motion control Serial link HART SSI encoder Counter
Checks	Process control
Control channels	Programmable loops
Integrated connection type	1 Ethernet TCP/IP service port 2 Ethernet TCP/IP device network USB type mini B
Number of remote I/O station	31 - 2 remote drop
Number of distributed equipment	64
Communication module processor capacity	16 AS-Interface module 6 Ethernet communication module
Communication Service	RIO scanner DIO scanner
Memory description	Expandable flash, 4 GB data storage Integrated RAM, 10 kB system memory Integrated RAM, 24 MB program Integrated RAM, 4096 kB data
Application structure	1 periodic fast task 2 auxiliary tasks 128 event tasks 1 cyclic/periodic master task
Number of instructions per ms	40 Kinst/ms 65 % Boolean + 35 % fixed arithmetic 50 Kinst/ms 100 % Boolean
Current consumption	300 mA 24 V DC
MTBF reliability	775000 H

Price is "List Price" and may be subject to a trade discount – check with your local distributor or retailer for actual price.

Marking	CE
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## Environment

Vibration resistance	3 gn
Shock resistance	30 gn
Ambient Air Temperature for Operation	-13...140 °F (-25...60 °C)
Ambient Air Temperature for Storage	-40...185 °F (-40...85 °C)
Operating altitude	0...6561.68 ft (0...2000 m) 2000...5000 m with derating factor
Relative humidity	5...95 % 131 °F (55 °C) without condensation
IP Degree of Protection	IP20
Directives	2014/35/EU - low voltage directive 2014/30/EU - electromagnetic compatibility 2014/34/EU - ATEX directive
Product certifications	CE UL CSA RCM EAC Merchant Navy ATEX zone 2/22 IECEx zone 2/22
Standards	IEC 61131-2 IEC 61010-2-201 UL 61010-2-201 CSA C22.2 No 61010-2-201 IACS E10 EN/IEC 61000-6-5, interface type 1 and type 2 EN/IEC 61850-3, location G IEC 60079-0
Environmental characteristic	Gas resistant class Gx ISA S71.04 Gas resistant class 3C4 IEC 60721-3-3 Dust resistant class 3S4 IEC 60721-3-3 Sand resistant class 3S4 IEC 60721-3-3 Salt resistant level 2 IEC 68252 Mold growth resistant class 3B2 IEC 60721-3-3 Fungal spore resistant class 3B2 IEC 60721-3-3 Hazardous location class I division 2
Protective treatment	Conformal coating
Supply	Internal power supply via rack
Status LED	1 LED (Green) processor running (RUN) 1 LED (Red) processor or system fault (ERR) 1 LED (Red) I/O module fault (I/O) 1 LED (Green) download in progress (DL) 1 LED (Red) memory card or CPU flash fault (BACKUP) 1 LED (green/red) ETH MS (Ethernet port configuration status) 1 LED (green/red) Eth NS (Ethernet network status) 1 LED (Green) I/O values overridden by user (FORCED IO)
Net Weight	1.872 lb(US) (0.849 kg)

## Ordering and shipping details

Category	US1PC3418161
Discount Schedule	PC34
GTIN	3606485440040
Returnability	No
Country of origin	FR

## Packing Units

Unit Type of Package 1	PCE
Nbr. of units in pkg.	1
Package 1 Height	3.346 in (8.500 cm)
Package 1 Width	6.890 in (17.500 cm)
Package 1 Length	9.843 in (25.000 cm)
Package weight(Lbs)	31.041 oz (880.000 g)
Unit Type of Package 2	S03
Number of Units in Package 2	6
Package 2 Height	11.811 in (30.000 cm)
Package 2 Width	11.811 in (30.000 cm)
Package 2 Length	15.748 in (40.000 cm)
Package 2 Weight	12.632 lb(US) (5.730 kg)



## Environmental Data

Schneider Electric aims to achieve Net Zero status by 2050 through supply chain partnerships, lower impact materials, and circularity via our ongoing “Use Better, Use Longer, Use Again” campaign to extend product lifetimes and recyclability.

[Environmental Data explained >](#)

[How we assess product sustainability >](#)

### Environmental footprint

Carbon footprint (kg CO2 eq, Total Life cycle) 249

Environmental Disclosure [Product Environmental Profile](#)

## Use Better

### Materials and Substances

Packaging made with recycled cardboard Yes

Packaging without single use plastic No

[EU RoHS Directive](#) Pro-active compliance (Product out of EU RoHS legal scope)

SCIP Number 4eb70ab0-978b-4773-a441-0cc20d6144a1

REACH Regulation [REACH Declaration](#)

California proposition 65 **WARNING:** This product can expose you to chemicals including: Lead and lead compounds, which is known to the State of California to cause cancer and birth defects or other reproductive harm. For more information go to [www.P65Warnings.ca.gov](http://www.P65Warnings.ca.gov)

## Use Again

### Repack and remanufacture

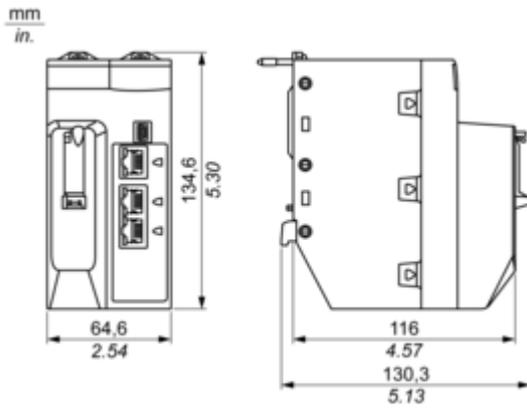
Circularity Profile [End of Life Information](#)

Take-back No

Dimensions Drawings

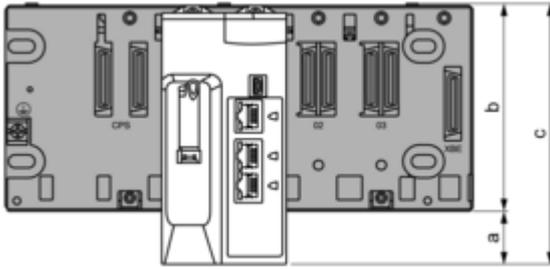
CPU Module Only

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**Modules Mounted on Racks**

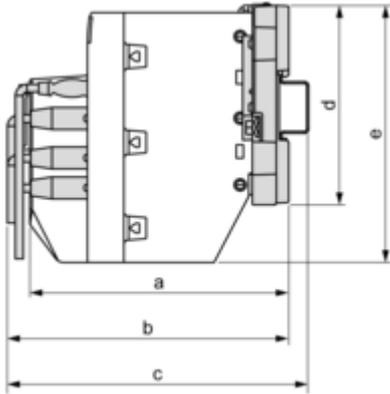
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- a:** additional space below the rack to accommodate the height of the CPU. For an X Bus rack, the value is 30.9 mm (1.217 in.); for an Ethernet rack, the value is 29.49 mm (1.161 in.).
- b:** the height of the rack. For an X Bus rack, the height is 103.7 mm (4.083 in.); for an Ethernet rack, the height is 105.11 mm (4.138 in.).
- c:** the height of the main local rack, 134.6 mm (5.299 in.)

**Modules and Cables Mounted in an Enclosure**

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**a:** enclosure depth: 135 mm (5.315 in.)

**b:** wiring + module depth: > 146 mm (5.748 in.)

**c:** wiring + module + DIN rail depth: > 156 mm (6.142 in.)

**d:** rack height: for an X Bus rack 103.7 mm (4.083 in.); for an Ethernet rack, 105.11 mm (4.138 in.)

**e:** module height: 134.6 mm (5.299 in.)

Image of product / Alternate images

Alternative

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